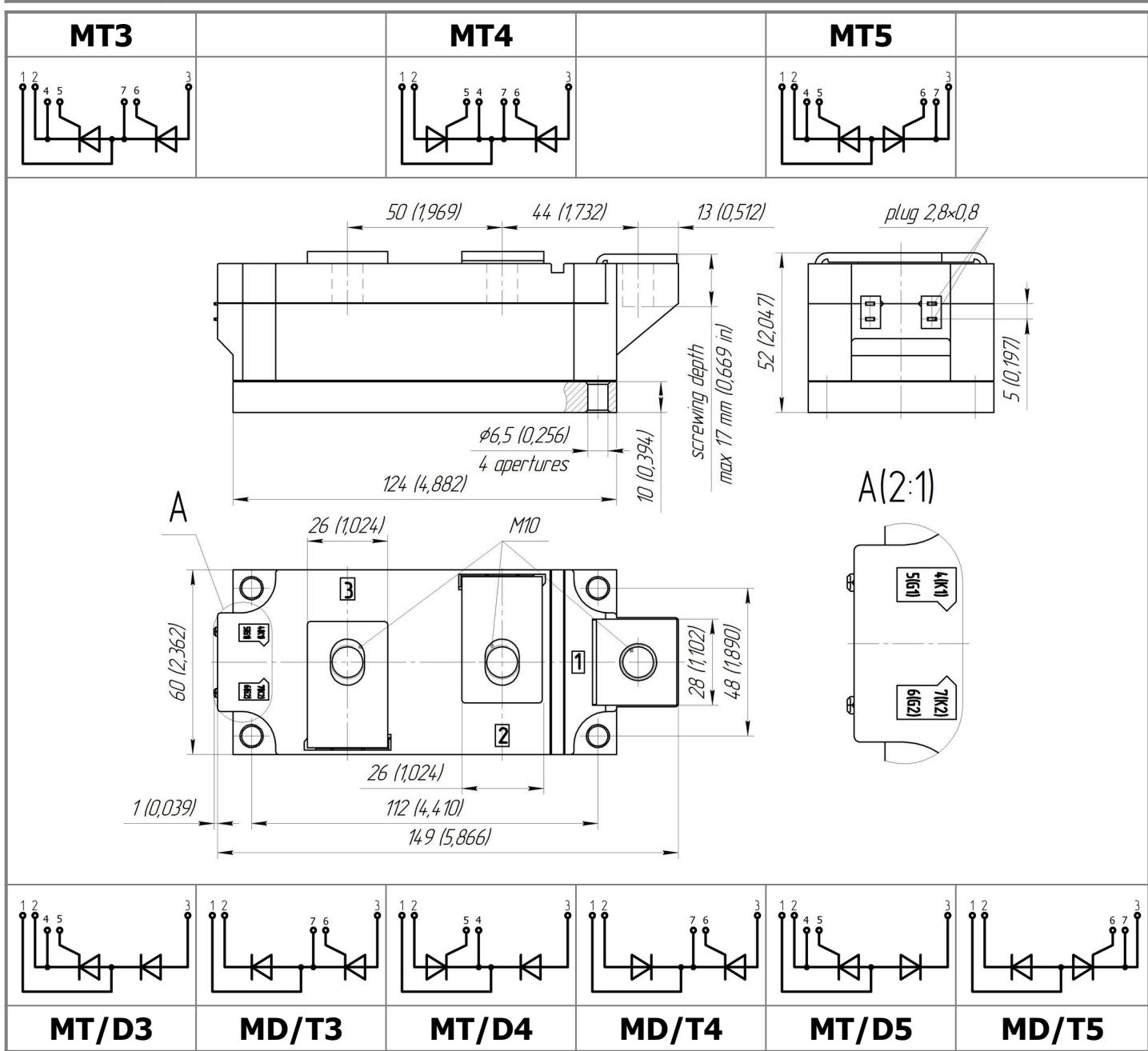




Electrically isolated base plate
 Industrial standard package
 Simplified mechanical design, rapid assembly
 Pressure contact

Double Thyristor Module For Phase Control **MTx-540-18-A2**

Mean on-state current	I _{TAV}	540 A		
Repetitive peak off-state voltage	V _{DRM}	1400 ÷ 1800 V		
Repetitive peak reverse voltage	V _{RRM}			
Turn-off time	t _q	250 µs		
V _{DRM} , V _{RRM} , V	1400	1500	1600	1800
Voltage code	14	15	16	18
T _j , °C	- 40 ÷ 130			



All dimensions in millimeters (inches)

MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions	
ON-STATE					
I _{TAV}	Mean on-state current	A	540	T _c =85 °C;	
I _{TRMS}	RMS on-state current	A	845	180° half-sine wave; 50 Hz	
I _{TSM}	Surge on-state current	kA	15.5 18.0	T _j =T _j max T _j =25 °C	180° half-sine wave; t _p =10 ms; single pulse; V _D =V _R =0 V; Gate pulse: I _G =2 A; t _{GP} =50 μs; di _G /dt≥1 A/μs
			16.0 18.0	T _j =T _j max T _j =25 °C	180° half-sine wave; t _p =8.3 ms; single pulse; V _D =V _R =0 V; Gate pulse: I _G =2 A; t _{GP} =50 μs; di _G /dt≥1 A/μs
I ² t	Safety factor	A ² s·10 ³	1200 1600	T _j =T _j max T _j =25 °C	180° half-sine wave; t _p =10 ms; single pulse; V _D =V _R =0 V; Gate pulse: I _G =2 A; t _{GP} =50 μs; di _G /dt≥1 A/μs
			1000 1300	T _j =T _j max T _j =25 °C	180° half-sine wave; t _p =8.3 ms; single pulse; V _D =V _R =0 V; Gate pulse: I _G =2 A; t _{GP} =50 μs; di _G /dt≥1 A/μs
BLOCKING					
V _{DRM} , V _{RRM}	Repetitive peak off-state and Repetitive peak reverse voltages	V	1400÷1800	T _{j min} < T _j <T _j max;	180° half-sine wave; 50 Hz; Gate open
V _{DSM} , V _{RSM}	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	1500÷1900	T _{j min} < T _j <T _j max;	180° half-sine wave; single pulse; Gate open
V _D , V _R	Direct off-state and Direct reverse voltages	V	0.6·V _{DRM} 0.6·V _{RRM}	T _j =T _j max;	Gate open
TRIGGERING					
I _{FGM}	Peak forward gate current	A	8	T _j =T _j max	
V _{RGM}	Peak reverse gate voltage	V	5		
P _G	Gate power dissipation	W	4	T _j =T _j max	for DC gate current
SWITCHING					
(di _T /dt) _{crit}	Critical rate of rise of on-state current non-repetitive (f=1 Hz)	A/μs	400	T _j =T _j max; V _D =0.67·V _{DRM} ; I _{TM} =2 I _{TAV} ;	Gate pulse: I _G =2 A; t _{GP} =50 μs; di _G /dt≥2 A/μs
THERMAL					
T _{stg}	Storage temperature	°C	-40 ÷ 50		
T _j	Operating junction temperature	°C	-40 ÷ 130		
T _{c op}	Operating temperature	°C	-40 ÷ 125		
MECHANICAL					
a	Acceleration under vibration	m/s ²	50		

CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions
ON-STATE				
V _{TM}	Peak on-state voltage, max	V	1.50	T _j =25 °C; I _{TM} =1570 A
V _{T(TO)}	On-state threshold voltage, max	V	0.85	T _j =T _j max;
r _T	On-state slope resistance, max	mΩ	0.320	0.5 π I _{TAV} < I _T < 1.5 π I _{TAV}
I _L	Latching current, max	mA	1000	T _j =25 °C; V _D =12 V; Gate pulse: I _G =2 A; t _{GP} =50 μs; di _G /dt≥1 A/μs
I _H	Holding current, max	mA	300	T _j =25 °C; V _D =12 V; Gate open
BLOCKING				
I _{DRM} , I _{RRM}	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	70	T _j =T _j max; V _D =V _{DRM} ; V _R =V _{RRM}
(dv _D /dt) _{crit}	Critical rate of rise of off-state voltage ¹⁾ , min	V/μs	1000	T _j =T _j max; V _D =0.67·V _{DRM} ; Gate open
TRIGGERING				
V _{GT}	Gate trigger direct voltage, max	V	4.00 2.50 2.00	T _j = T _j min T _j =25 °C T _j = T _j max
I _{GT}	Gate trigger direct current, max	mA	400 250 200	T _j = T _j min T _j = 25 °C T _j = T _j max
V _{GD}	Gate non-trigger direct voltage, min	V	0.25	T _j =T _j max; V _D =0.67·V _{DRM} ;
I _{GD}	Gate non-trigger direct current, min	mA	10.00	Direct gate current
SWITCHING				
t _{gd}	Delay time	μs	2.00	T _j =25 °C; V _D =1000 V; I _{TM} =I _{TAV} ; di/dt=200 A/μs; Gate pulse: I _G =2 A; V _G =20 V; t _{GP} =50 μs; di _G /dt=2 A/μs
t _q	Turn-off time ²⁾ , max	μs	250	dv _D /dt=50 V/μs; T _j =T _j max; I _{TM} = I _{TAV} ; di _R /dt=10 A/μs; V _R =100V; V _D =0.67 V _{DRM} ;
THERMAL				
R _{thjc}	Thermal resistance, junction to case			
	per module	°C/W	0.0325	
	per arm	°C/W	0.0650	180° half-sine wave, 50 Hz
	per module	°C/W	0.0310	
	per arm	°C/W	0.0620	DC
R _{thch}	Thermal resistance, case to heatsink			
	per module	°C/W	0.0100	
	per arm	°C/W	0.0200	
INSULATION				
V _{ISOL}	Insulation test voltage	kV	3.00	Sine wave, 50 Hz; t=60 sec
			3.60	RMS t=1 sec
MECHANICAL				
M ₁	Mounting torque (M6) ³⁾	Nm	6.00	Tolerance ± 15%
M ₂	Terminal connection torque (M10) ³⁾	Nm	12.00	Tolerance ± 15%
w	Weight, max	g	1500	

PART NUMBERING GUIDE									NOTES
MT 3 - 540 - 18 - A2 M2 - A2 - N									1) Critical rate of rise of off-state voltage
1 2	3	4	5	6	7	8			Symbol of group A2
1. Thyristor module (MT) Thyristor – Diode module (MT/D) Diode – Thyristor module (MD/T)									(dv _D /dt) _{crit} , V/μs 1000
2. Circuit Schematic: 3 – serial connection 4 – common Cathode 5 – common Anode									2) Turn-off time (dv _D /dt=50 V/μs)
3. Average On-state Current, A 4. Voltage Code 5. Critical rate of rise of off-state voltage 6. Group of turn-off time (dv _D /dt=50 V/μs) 7. Package Type (M.A2) 8. Ambient Conditions: N – Normal									Symbol of group M2 t _q , μs 250 3) The screws must be lubricated



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